

74LVX161284A Low Voltage IEEE 161284 Translating Transceiver

General Description

The LVX161284A contains eight bidirectional data buffers and eleven control/status buffers to implement a full IEEE 1284 compliant interface. The device supports the IEEE 1284 standard, with the exception of output slew rate, and is intended to be used in an Extended Capabilities Port mode (ECP). The pinout allows for easy connection from the Peripheral (A-side) to the Host (cable side).

Outputs on the cable side can be configured to be either open drain or high drive (± 14 mA) and are connected to a separate power supply pin (V_{CC} —cable) to allow these outputs to be driven by a higher supply voltage than the A-side. The pull-up and pull-down series termination resistance of these outputs on the cable side is optimized to drive an external cable. In addition, all inputs (except HLH) and outputs on the cable side contain internal pull-up resistors connected to the V_{CC} —cable supply to provide proper termination and pull-ups for open drain mode.

Outputs on the Peripheral side are standard low-drive CMOS outputs designed to interface with 3V logic. The DIR

input controls data flow on the A_1 – A_8 / B_1 – B_8 transceiver pins.

Features

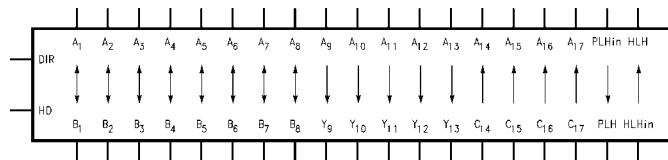
- Supports IEEE 1284 Level 1 and Level 2 signaling standards for bidirectional parallel communications between personal computers and printing peripherals with the exception of output slew rate
- Translation capability allows outputs on the cable side to interface with 5V signals
- All inputs have hysteresis to provide noise margin
- B and Y output resistance optimized to drive external cable
- B and Y outputs in high impedance mode during power down
- Inputs and outputs on cable side have internal pull-up resistors
- Flow-through pin configuration allows easy interface between the "Peripheral and Host"
- Replaces the function of two (2) 74ACT1284 devices

Ordering Code

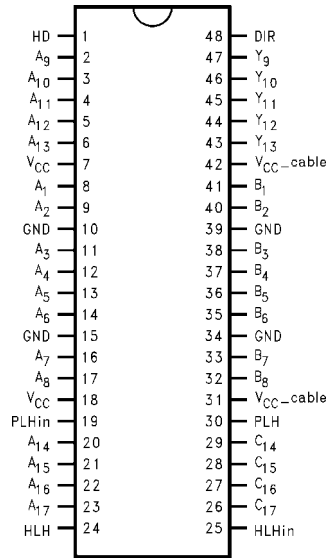
Order Number	Package Number	Package Description
74LVX161284AMTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Description
HD	High Drive Enable Input (Active High)
DIR	Direction Control Input
A ₁ –A ₈	Inputs or Outputs
B ₁ –B ₈	Inputs or Outputs
A ₉ –A ₁₃	Inputs
Y ₉ –Y ₁₃	Outputs
A ₁₄ –A ₁₇	Outputs
C ₁₄ –C ₁₇	Inputs
PLH _{IN}	Peripheral Logic High Input
PLH	Peripheral Logic High Output
HLH _{IN}	Host Logic High Input
HLH	Host Logic High Output

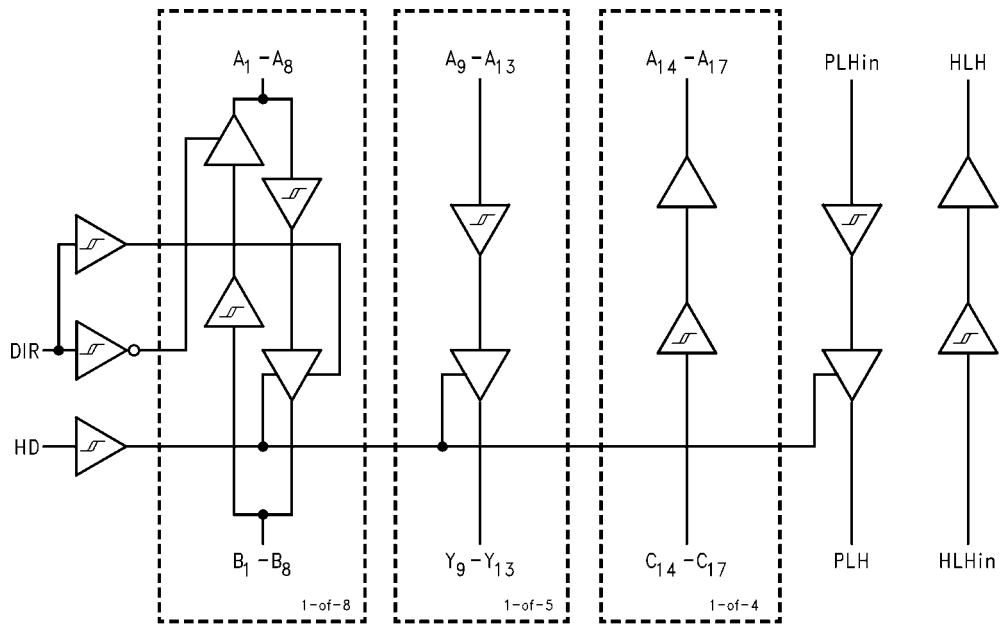
Truth Table

Inputs		Outputs
DIR	HD	
L	L	B ₁ –B ₈ Data to A ₁ –A ₈ , and A ₉ –A ₁₃ Data to Y ₉ –Y ₁₃ (Note 1) C ₁₄ –C ₁₇ Data to A ₁₄ –A ₁₇ PLH Open Drain Mode
L	H	B ₁ –B ₈ Data to A ₁ –A ₈ , and A ₉ –A ₁₃ Data to Y ₉ –Y ₁₃ C ₁₄ –C ₁₇ Data to A ₁₄ –A ₁₇
H	L	A ₁ –A ₈ Data to B ₁ –B ₈ (Note 2) A ₉ –A ₁₃ Data to Y ₉ –Y ₁₃ (Note 1) C ₁₄ –C ₁₇ Data to A ₁₄ –A ₁₇ PLH Open Drain Mode
H	H	A ₁ –A ₈ Data to B ₁ –B ₈ A ₉ –A ₁₃ Data to Y ₉ –Y ₁₃ C ₁₄ –C ₁₇ Data to A ₁₄ –A ₁₇

Note 1: Y₉–Y₁₃ Open Drain Outputs

Note 2: B₁–B₈ Open Drain Outputs

Logic Diagram



74LVX161284A

Absolute Maximum Ratings (Note 3)		Output Diode Current (I_{OK})	
Supply Voltage		$A_1-A_8, A_{14}-A_{17}, HLH$	± 50 mA
V_{CC}	-0.5V to +4.6V	B_1-B_8, Y_9-Y_{13}, PLH	-50 mA
$V_{CC-Cable}$	-0.5V to +7.0V	DC Continuous V_{CC} or Ground Current	± 200 mA
$V_{CC-Cable}$ Must Be $\geq V_{CC}$		Storage Temperature	-65°C to +150°C
Input Voltage (V_I)—(Note 4)		ESD (HBM) Last Passing Voltage	2000V
$A_1-A_{13}, PLH_{IN}, DIR, HD$	-0.5V to $V_{CC} + 0.5V$	Recommended Operating Conditions	
$B_1-B_8, C_{14}-C_{17}, HLH_{IN}$	-0.5V to +5.5V (DC)	Supply Voltage	
$B_1-B_8, C_{14}-C_{17}, HLH_{IN}$	-2.0V to +7.0V*	V_{CC}	3.0V to 3.6V
	*40 ns Transient	$V_{CC-Cable}$	3.0V to 5.5V
Output Voltage (V_O)		DC Input Voltage (V_I)	0V to V_{CC}
$A_1-A_8, A_{14}-A_{17}, HLH$	-0.5V to $V_{CC} + 0.5V$	Open Drain Voltage (V_O)	0V to 5.5V
B_1-B_8, Y_9-Y_{13}, PLH	-0.5V to +5.5V (DC)	Operating Temperature (T_A)	-40°C to +85°C
B_1-B_8, Y_9-Y_{13}, PLH	-2.0V to +7.0V*		
	*40 ns Transient	Note 3: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.	
DC Output Current (I_O)		Note 4: Either voltage limit or current limit is sufficient to protect inputs.	
A_1-A_8, HLH	± 25 mA		
B_1-B_8, Y_9-Y_{13}	± 50 mA		
PLH (Output LOW)	84 mA		
PLH (Output HIGH)	-50 mA		
Input Diode Current (I_{IK})—(Note 4)			
$DIR, HD, A_9-A_{13}, PLH, HLH, C_{14}-C_{17}$	-20 mA		

DC Electrical Characteristics

Symbol	Parameter		V_{CC} (V)	$V_{CC-Cable}$ (V)	$T_A = -40^\circ\text{C to } +85^\circ\text{C}$		Units	Conditions
					Guaranteed Limits			
V_{IK}	Input Clamp Diode Voltage		3.0	3.0	-1.2		V	$I_i = -18$ mA
V_{IH}	Minimum	$A_n, B_n, PLH_{IN}, DIR, HD$	3.0-3.6	3.0-5.5	2.0		V	
	High Level	C_n	3.0-3.6	3.0-5.5	2.3			
	Input Voltage	HLH_{IN}	3.0-3.6	3.0-5.5	2.6			
V_{IL}	Maximum	$A_n, B_n, PLH_{IN}, DIR, HD$	3.0-3.6	3.0-5.5	0.8		V	
	Low Level	C_n	3.0-3.6	3.0-5.5	0.8			
	Input Voltage	HLH_{IN}	3.0-3.6	3.0-5.5	1.6			
ΔV_T	Minimum Input Hysteresis	$A_n, B_n, PLH_{IN}, DIR, HD$	3.3	5.0	0.4		V	$V_T^+ - V_T^-$ $V_T^+ - V_T^-$ $V_T^+ - V_T^-$
		C_n	3.3	5.0	0.8			
		HLH_{IN}	3.3	5.0	0.2			
V_{OH}	Minimum High Level Output Voltage	A_n, HLH	3.0	3.0	2.8		V	$I_{OH} = -50$ μ A
		B_n, Y_n	3.0	3.0	2.4			$I_{OH} = -4$ mA
		B_n, Y_n	3.0	4.5	2.0			$I_{OH} = -14$ mA
		PLH	3.15	3.15	2.23			$I_{OH} = -14$ mA
V_{OL}	Maximum Low Level Output Voltage	A_n, HLH	3.0	3.0	0.2		V	$I_{OL} = 50$ μ A
		B_n, Y_n	3.0	3.0	0.4			$I_{OL} = 4$ mA
		B_n, Y_n	3.0	3.0	0.8			$I_{OL} = 14$ mA
		B_n, Y_n	3.0	4.5	0.77			$I_{OL} = 14$ mA
		PLH	3.0	3.0	0.95			$I_{OL} = 84$ mA
		PLH	3.0	4.5	0.9			$I_{OL} = 84$ mA
R_D	Maximum Output Impedance	B_1-B_8, Y_9-Y_{13}	3.3	3.3	60		Ω	(Note 5)
			3.3	5.0	55			(Note 7)
	Minimum Output Impedance	B_1-B_8, Y_9-Y_{13}	3.3	3.3	30			(Note 5)
			3.3	5.0	35			(Note 7)

DC Electrical Characteristics (Continued)								
Symbol	Parameter		V _{CC} (V)	V _{CC-Cable} (V)	T _A = -40°C to +85°C	Units	Conditions	
					Guaranteed Limits			
R _P	Maximum Pull-Up Resistance	B ₁ -B ₈ , Y ₉ -Y ₁₃ , C ₁₄ -C ₁₇	3.3	3.3	1650	Ω		
		B ₁ -B ₈ , Y ₉ -Y ₁₃ C ₁₄ -C ₁₇	3.3	5.0	1650			
I _{IH}	Maximum Input Current in High State	A ₉ -A ₁₃ , PLH _{IN} , HD, DIR, HLH _{IN}	3.6	3.6	1.0	μA	V _I = 3.6V	
		C ₁₄ -C ₁₇	3.6	3.6	50.0		V _I = 3.6V	
		C ₁₄ -C ₁₇	3.6	5.5	100		V _I = 5.5V	
I _{IL}	Maximum Input Current in Low State	A ₉ -A ₁₃ , PLH _{IN} , HD, DIR, HLH _{IN}	3.6	3.6	-1.0	μA	V _I = 0.0V	
		C ₁₄ -C ₁₇	3.6	3.6	-3.5		mA	V _I = 0.0V
		C ₁₄ -C ₁₇	3.6	5.5	-5.0		mA	V _I = 0.0V
I _{OZH}	Maximum Output Disable Current (High)	A ₁ -A ₈	3.6	3.6	20	μA	V _O = 3.6V	
		B ₁ -B ₈	3.6	3.6	50		μA	V _O = 3.6V
		B ₁ -B ₈	3.6	5.5	100		μA	V _O = 5.5V
I _{OZL}	Maximum Output Disable Current (Low)	A ₁ -A ₈	3.6	3.6	-20	μA	V _O = 0.0V	
		B ₁ -B ₈	3.6	3.6	-3.5		mA	
		B ₁ -B ₈	3.6	5.5	-5.0		mA	
I _{OFF}	Power Down Output Leakage	B ₁ -B ₈ , Y ₉ -Y ₁₃ , PLH	0.0	0.0	100	μA	V _O = 5.5V	
I _{OFF}	Power Down Input Leakage	C ₁₄ -C ₁₇ , HLH _{IN}	0.0	0.0	100	μA	V _I = 5.5V	
I _{OFF-ICC}	PowerDown Leakage to V _{CC}		0.0	0.0	250	μA	(Note 6)	
I _{OFF-ICC2}	Power Down Leakage to V _{CC-Cable}		0.0	0.0	250	μA	(Note 6)	
I _{CC}	Maximum Supply Current		3.6	3.6	45	mA	V _I = V _{CC} or GND	
			3.6	5.5	70		V _I = V _{CC} or GND	

Note 5: Output impedance is measured with the output active low and active high (HD = high).

Note 6: Power-down leakage to V_{CC} or V_{CC-Cable} is tested by simultaneously forcing all pins on the cable-side (B₁-B₈, Y₉-Y₁₃, PLH, C₁₄-C₁₇ and HLH_{IN}) to 5.5V and measuring the resulting I_{CC} or I_{CC-Cable}.

Note 7: This parameter is guaranteed but not tested, characterized only.

AC Electrical Characteristics

Symbol	Parameter	T _A = -40°C to +85°C V _{CC} = 3.0V-3.6V V _{CC-Cable} = 4.5V-5.5V		Units	Fig. No.
		Min	Max		
t _{PHL}	A ₁ -A ₈ to B ₁ -B ₈	1.0	8.5	ns	1
t _{PLH}	A ₁ -A ₈ to B ₁ -B ₈	1.0	8.5	ns	2
t _{PHL}	B ₁ -B ₈ to A ₁ -A ₈	1.0	14.0	ns	3
t _{PLH}	B ₁ -B ₈ to A ₁ -A ₈	1.0	14.0	ns	3
t _{PHL}	A ₉ -A ₁₃ to Y ₉ -Y ₁₃	1.0	8.5	ns	1
t _{PLH}	A ₉ -A ₁₃ to Y ₉ -Y ₁₃	1.0	8.5	ns	2
t _{PHL}	C ₁₄ -C ₁₇ to A ₁₄ -A ₁₇	1.0	10.0	ns	3
t _{PLH}	C ₁₄ -C ₁₇ to A ₁₄ -A ₁₇	1.0	10.0	ns	3
t _{SKEW}	LH-LH or HL-HL		2.0	ns	(Note 9)
t _{PHL}	PLH _{IN} to PLH	1.0	8.5	ns	1
t _{PLH}	PLH _{IN} to PLH	1.0	8.5	ns	2
t _{PHL}	HLH _{IN} to HLH	1.0	10.0	ns	3
t _{PLH}	HLH _{IN} to HLH	1.0	12.0	ns	3
t _{PHZ}	Output Disable Time	1.0	10.0	ns	7
t _{PLZ}	DIR to A ₁ -A ₈	1.0	10.0	ns	
t _{PZH}	Output Enable Time	1.0	10.0	ns	8
t _{PZL}	DIR to A ₁ -A ₈	1.0	10.0	ns	
t _{PHZ}	Output Disable Time	1.0	13.0	ns	9
t _{PLZ}	DIR to B ₁ -B ₈	1.0	10.0	ns	
t _{pEN}	Output Enable Time HD to B ₁ -B ₈ , Y ₉ -Y ₁₃	1.0	8.0	ns	2
t _{pDIS}	Output Disable Time HD to B ₁ -B ₈ , Y ₉ -Y ₁₃	1.0	12.0	ns	2

Note 8: Open Drain

Note 9: t_{SKEW} is measured for common edge output transitions and compares the measured propagation delay for a given path type:

- (i) A₁-A₈ to B₁-B₈, A₉-A₁₃ to Y₉-Y₁₃
- (ii) B₁-B₈ to A₁-A₈
- (iii) C₁₄-C₁₇ to A₁₄-A₁₇

Note 10: Pulse Generator for all pulses; Rate ≤ 1.0 MHz; Z_O ≤ 50Ω; t_r ≤ 2.5 ns, t_f ≤ 2.5 ns.

Capacitance

Symbol	Parameter	Typ	Units	Conditions
C _{IN}	Input Capacitance	3	pF	V _{CC} = 0.0V (HD, DIR, A ₉ -A ₁₃ , C ₁₄ -C ₁₇ , PLH _{IN} and HLH _{IN})
C _{I/O} (Note 11)	I/O Pin Capacitance	5	pF	V _{CC} = 3.3V

Note 11: C_{I/O} is measured at frequency = 1 MHz, per MIL-STD-883B, Method 3012

AC Loading and Waveforms

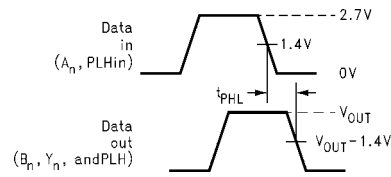
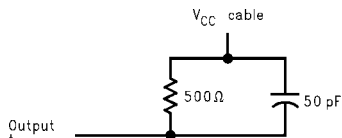


FIGURE 1. t_{PHL} Test Load and Waveforms

**A₁-A₈ to B₁-B₈
A₉-A₁₃ to Y₉-Y₁₃
PLHin to PLH**

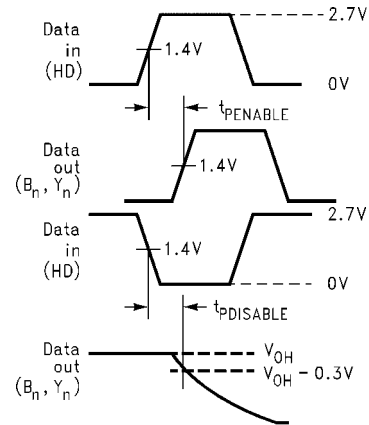
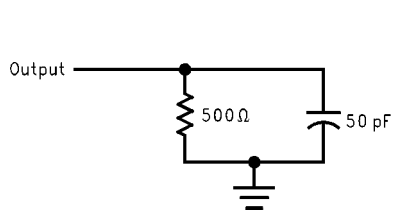
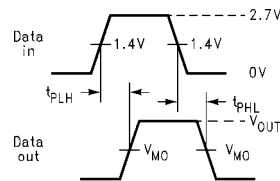
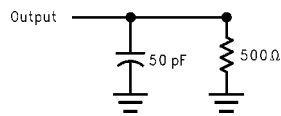


FIGURE 2. t_{PLH} , t_{PEn} , t_{PDis} Test Load and Waveforms

**A₁-A₈ to B₁-B₈, A₉-A₁₃ to Y₉-Y₁₃
PLHin to PLH, HD to B₁-B₈, Y₉-Y₁₃, PLH**



$V_{MO} = 50\% V_{CC}$

FIGURE 3. t_{PHL} , t_{PLH} Test Load and Waveforms

B₁-B₈ to A₁-A₈, C₁₄-C₁₇ to A₁₄-A₁₇, HLHin to HLH

AC Loading and Waveforms (Continued)

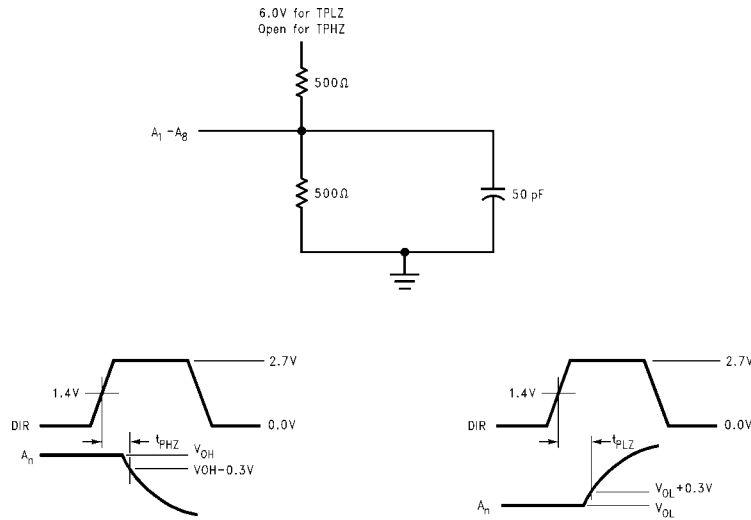


FIGURE 4. t_{PHZ} and t_{PLZ} Test Load and Waveforms, DIR to A₁-A₈

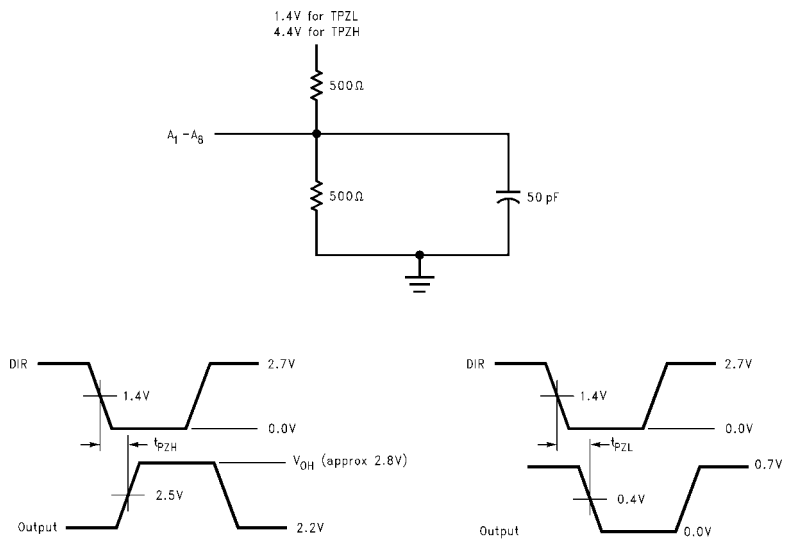


FIGURE 5. t_{PZH} and t_{PZL} Test Load and Waveforms, DIR to A₁-A₈

AC Loading and Waveforms (Continued)

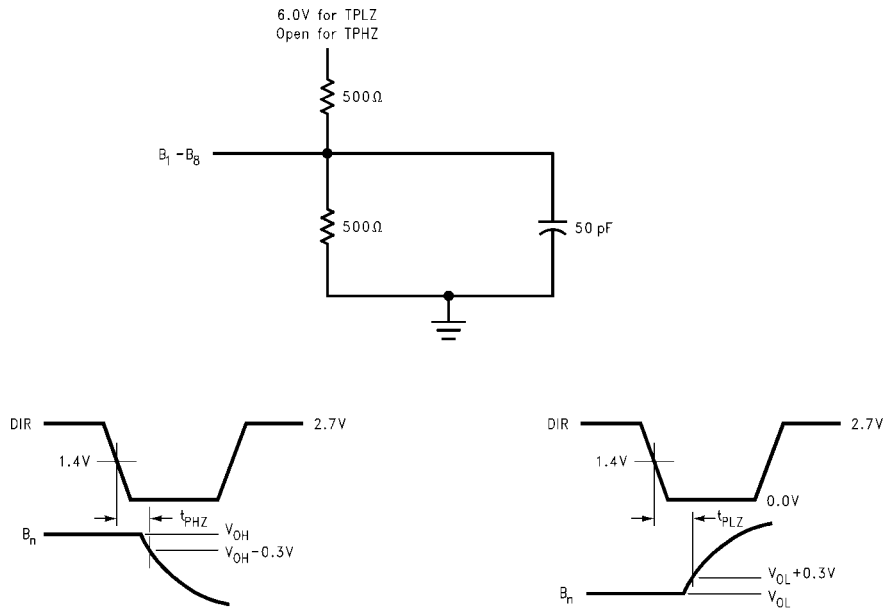
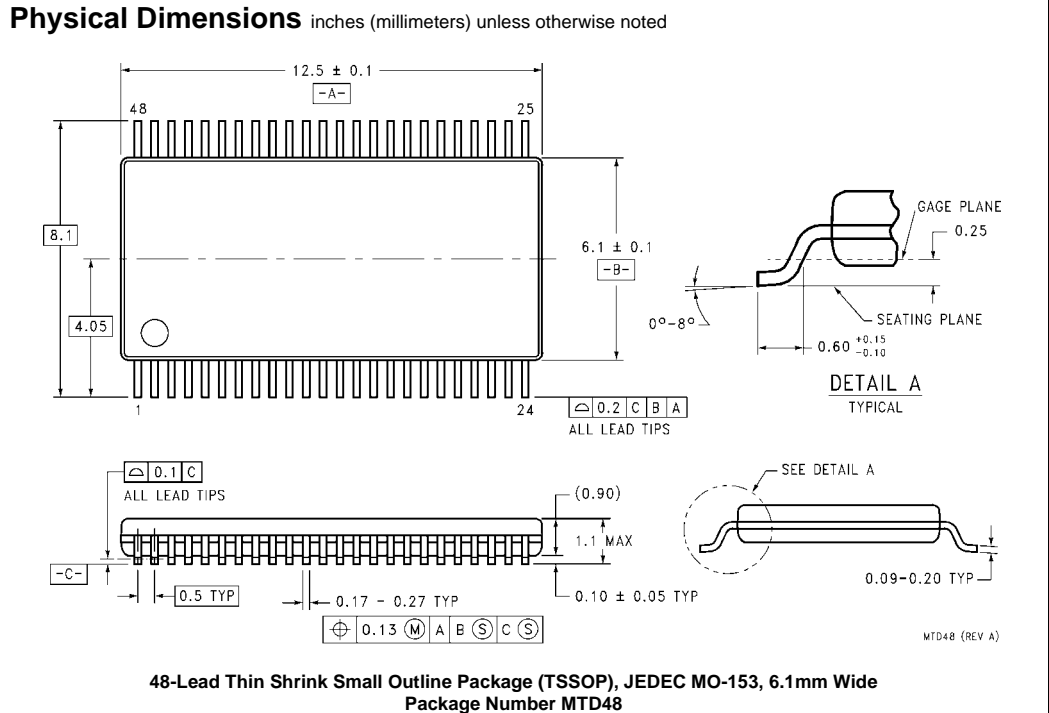


FIGURE 6. t_{PHZ} and t_{PLZ} Test Load and Waveforms
DIR to B₁-B₈



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